

Title (en)

METHOD OF PRODUCING A COMPONENT SHIELDED FROM ELECTROMAGNETIC RADIATION

Title (de)

VERFAHREN ZUR HERSTELLUNG EINES GEGENÜBER ELEKTROMAGNETISCHER STRAHLUNG ABGESCHIRMTE BAUTEILS

Title (fr)

PROCÉDÉ DE FABRICATION D'UN COMPOSANT BLINDÉ VIS-À-VIS D'UN RAYONNEMENT ÉLECTROMAGNÉTIQUE

Publication

**EP 3994965 A1 20220511 (DE)**

Application

**EP 20735363 A 20200629**

Priority

- DE 102019118092 A 20190704
- EP 2020068200 W 20200629

Abstract (en)

[origin: WO2021001298A1] The present invention relates to a method for producing a substrate shielded from electromagnetic radiation, to substrates and devices obtainable according to said method and uses thereof for shielding electromagnetic radiation, especially in the field of electromobility.

IPC 8 full level

**H05K 9/00** (2006.01)

CPC (source: CN EP KR US)

**B29C 45/0013** (2013.01 - US); **B29C 45/164** (2013.01 - US); **C08F 297/04** (2013.01 - US); **C08K 3/04** (2013.01 - CN); **C08K 7/06** (2013.01 - CN); **C08K 13/04** (2013.01 - US); **C08L 53/02** (2013.01 - US); **C09D 5/24** (2013.01 - US); **C09D 7/61** (2018.01 - US); **C09D 7/70** (2018.01 - US); **C09D 153/02** (2013.01 - US); **H05K 9/0047** (2013.01 - EP KR US); **H05K 9/0083** (2013.01 - CN EP KR US); **H05K 9/009** (2013.01 - CN); **B29K 2009/06** (2013.01 - US); **B29K 2305/12** (2013.01 - US); **B29K 2307/04** (2013.01 - US); **B29K 2507/04** (2013.01 - US); **B29K 2995/0005** (2013.01 - US); **B29L 2031/30** (2013.01 - US); **C08K 3/04** (2013.01 - US); **C08K 7/06** (2013.01 - US); **C08K 2201/001** (2013.01 - CN US); **C08K 2201/014** (2013.01 - CN); **C08L 2203/20** (2013.01 - US); **C08L 2203/30** (2013.01 - US)

C-Set (source: CN)

1. **C08K 3/04 + C08L 53/025**
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Designated contracting state (EPC)

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Designated extension state (EPC)

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DOCDB simple family (publication)

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